



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#4
2181
10-2/03

OCT 03 2003

Applicant:

Ajit V. Sathe et al.

Title:

SOLDERLESS ELECTRONICS PACKAGING AND METHODS OF MANUFACTURE

Docket No.: 884.341US1

Serial No.: 09/726629

Filed: November 30, 2000

Due Date: N/A

Examiner: Xuan Thai

Group Art Unit: 2181

Customer No.: 21186

Confirmation No.: 2086

RECEIVED

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